IPC ASSOCIATION CONNECTED ELECTRONICS INDUST.	© Copyright 2005. IPG	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					Materials	and Mfg I	nformatio	n	
Supplier Infor	rmation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi												2024-05-02			
Contact Name			Title - Contact			F	Phone - Contact*				E	Email - Contact*			
Product-Env-Ste	wards		Product Enviro Compliance			1	NA				P	Product-Env-Stewards@onsemi.com			
uthorized Repre	esentative*	Title - Representative			F	Phone - Representative*				E	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			1	NA				P	Product-Env-Stewards@onsemi.com			
Reque	ester Item Number Mfr Iter		Item Number Mfr Item Name				Effective Dat	e Version	Version Manufacturing Site		Site	Wei	ght*	UOM	Unit Type
		NV24C64DTVLT		64KB I2C SER EEPROM for Low Vcc range			2024-05-02 PH1			31.2 mg		mg	Each		
Ianufacturin	g Proccess Informati	on													
Termin	nal Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	L Rating	Peak Process Body Temperature		Max Time a	at Peak Tei	ak Temperature Number of		r of Reflow Cyc	cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С	C 30		seconds 3			
Comments		•		•			•		•	•			•		
vel 1 - maximun	n time at peak temperatur	e during so	ldering is 10-3	0 seconds											
or more informa	ation regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an		
cadmium, hexavalentchromium, polybromir contains a RoHS restricted substance inexce encompass all such components. Supplier ce as of the date that Supplier completes this fo Company acknowledges that Supplier may l independently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated dipless of an applicable quantity limit, please intifies that it gathered the information it prome. Supplier acknowledges that Company have relied on information provided by other by others, Supplier agrees that, at a mining and the Supplier enter into a written agree esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substational substance below which, if any, RoHS exemption by desired in this form using appropriate method will rely on this certification in determining ters in completing this form, and that Supplies have provided certification between the will respect to the identified part, the Company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects to the identified part, the company's remedies for issues that arise respects the company is the co	ws of the European Union member states) of the pnce") in excess of the applicable quantity limit iden you believe may apply. If the part is an assemble is to ensure its accuracy and that such information the compliance of its products with European Union may not have independently verified such informs regarding their contributions to the part, and tho terms and conditions of that agreement, including the provides in this formation information the Supplier provides in this formation.	entified above. If a y with lower level is true and correct on member state la nation. However, in se certifications are any warranty rigl	n homogeneous material within the part components, the declaration shall t to the best of its knowledge and belief, aws that implement the RoHS Directive. In situations where Supplier has not e at least as comprehensive as the hts and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.66	mg	Supplier	Silicon (Si)	7440-21-3		0.66	mg
Die Attach	0.12	mg		Epoxy resin	proprietary data		0.012	mg
			Supplier	Silver (Ag)	7440-22-4		0.096	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.012	mg
Lead Frame	10.96	mg	Supplier	Zinc (Zn)	7440-66-6		0.0132	mg
			Supplier	Iron (Fe)	7439-89-6		0.2576	mg
			Supplier	Copper (Cu)	7440-50-8		10.686	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0033	mg
Mold Compound-Black	19.21	mg		Epoxy resin	proprietary data		1.4408	mg
			Supplier	Phenolic Resin	Proprietary Data		0.4802	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.4408	mg
			Supplier	Carbon Black (C)	1333-86-4		0.096	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		15.7522	mg
Plating	0.12	mg	Supplier	Palladium (Pd)	7440-05-3		0.006	mg
			В	Nickel (Ni)	7440-02-0		0.108	mg
			Supplier	Gold (Au)	7440-57-5		0.006	mg
Wire Bond - Au	0.13	mg	Supplier	Gold (Au)	7440-57-5		0.13	mg